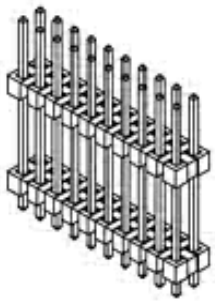
Part Number : 877970400
Product Description : C-Grid Header, Through Hole, Dual Row Dual Body, Vertical, 0.38µm Gold (Au) Plating, 12.70mm Stacking Height, Tray Packaging, 40 Circuits, Lead-Free
Series Number : 87797
Status : Active
Product Category : PCB Headers and Receptacles



Documents and Resources

Drawings

877970400_sd.pdf

PK-87797-300-000.pdf

PK-89990-489-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

713080001-AS-000.pdf

PS-87920-019-001.pdf

879200000-TS-000.pdf

879200001-TS-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per
EU ELV	Not Relevant
Low-Halogen Status	Not Relevant

REACH SVHC	Not Contained per D(2025)6375-DC (05 Nov 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements
- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87797
Description	C-Grid Header, Through Hole, Dual Row Dual Body, Vertical, 0.38µm Gold (Au) Plating, 12.70mm Stacking Height, Tray Packaging, 40 Circuits, Lead-Free
Application	Board-to-Board, Signal
Component Type	PCB Header
Product Name	C-Grid,Dual Body
UPC	822350598705

Agency

UL	E29179

Electrical

Current - Maximum per Contact	3.0A
Voltage - Maximum	250V

Physical

Breakaway	Yes
Circuits (Loaded)	40
Circuits (maximum)	40
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	5.025/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.79mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	2.032µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	No
Temperature Range - Operating	-55° to +105°C

Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	14
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	265